

OptiMOS®-P2 Power-Transistor

AEC® ® Qualified



Features

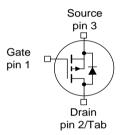
- P-channel Logic Level Enhancement mode
- AEC qualified
- MSL1 up to 260°C peak reflow
- 175°C operating temperature
- Green package (RoHS compliant)
- 100% Avalanche tested

Product Summary

V_{DS}	-40	V
R _{DS(on)}	7.8	$m\Omega$
I_{D}	-70	Α







Type Package Marking IPD70P04P4L-08 PG-TO252-3-313 4P04L08

Maximum ratings, at T_j =25 °C, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Continuous drain current	I _D	T _C =25°C, V _{GS} =-10V	-70	А
		T _C =100°C, V _{GS} =-10V ¹⁾	-55	
Pulsed drain current ¹⁾	I _{D,pulse}	T _C =25°C	-280	1
Avalanche energy, single pulse ¹⁾	E _{AS}	I _D =-35A	24	mJ
Avalanche current, single pulse	IAS	-	-70	А
Gate source voltage	V_{GS}	-	+5/-16	V
Power dissipation	P _{tot}	T _C =25 °C	75	W
Operating and storage temperature	$T_{\rm j},T_{\rm stg}$	-	-55 +175	°C
IEC climatic category; DIN IEC 68-1	-	-	55/175/56	



Parameter	Symbol	Conditions	Values		Unit	
			min.	typ.	max.	
Thermal characteristics ¹⁾						
Thermal resistance, junction - case	R_{thJC}	-	-	-	2.0	K/W
SMD version, device on PCB	R_{thJA}	minimal footprint	-	-	62	
		6 cm ² cooling area ²⁾	-	-	40	

Electrical characteristics, at T_j =25 °C, unless otherwise specified

Static characteristics

Drain-source breakdown voltage	$V_{(BR)DSS}$	V_{GS} =0V, I_D = -1mA	-40	-	-	V
Gate threshold voltage	$V_{\rm GS(th)}$	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = -120 \mu {\rm A}$	-1.2	-1.7	-2.2	
Zero gate voltage drain current	I _{DSS}	$V_{\rm DS}$ =-32V, $V_{\rm GS}$ =0V, $T_{\rm j}$ =25°C	1	-0.05	-1	μA
		V_{DS} =-32V, V_{GS} =0V, T_{j} =125°C ¹⁾	-	-20	-200	
Gate-source leakage current	I _{GSS}	V _{GS} =-16V, V _{DS} =0V	-	-	-100	nA
Drain-source on-state resistance	$R_{DS(on)}$	V _{GS} =-4.5V, I _D =-40A	-	9.5	12.9	mΩ
		V _{GS} =-10V, I _D =-70A	-	6.4	7.8	



Parameter	Symbol C	Conditions		Values		
			min.	typ.	max.	
Dynamic characteristics ¹⁾						
Input capacitance	Ciss		-	4177	5430	pF
Output capacitance	Coss	$V_{\rm GS}$ =0V, $V_{\rm DS}$ =-25V, f =1MHz	-	1185	1778	
Reverse transfer capacitance	C _{rss}		-	45	90	
Turn-on delay time	t _{d(on)}		-	12	-	ns
Rise time	t _r	$V_{\rm DD}$ =-20V, $V_{\rm GS}$ =-10V, $I_{\rm D}$ =-70A,	-	10	-	
Turn-off delay time	$t_{d(off)}$	$R_{G,\text{ext}}=3.5\Omega$	-	50	-	
Fall time	t_{f}		-	41	-	
Gate Charge Characteristics ¹⁾	Ta	T	I	ı	Ι	1 -
Gate to source charge	Q _{gs}	-	-	14	18	nC
Gate to drain charge	Q _{gd}	V_{DD} =-32V, I_{D} =-70A,	-	10	20	
Gate charge total	Qg	V _{GS} =0 to -10V	-	71	92	
Gate plateau voltage	$V_{ m plateau}$		-	-3.5	-	V
Reverse Diode						
Diode continous forward current ¹⁾	Is	T -25°C	-	-	-70	А
Diode pulse current ¹⁾	I _{S,pulse}	− T _C =25°C	-	-	-280	
Diode forward voltage	V _{SD}	V _{GS} =0V, I _F =-70A, T _j =25°C	-	-1	-1.3	V
Reverse recovery time ¹⁾	t _{rr}	V_R =-20V, I_F =-50A, di_F/dt =-100A/ μ s	-	46	-	ns
Reverse recovery charge ¹⁾	Q _{rr}		-	43	-	nC

¹⁾ Defined by design. Not subject to production test.

²⁾ Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 µm thick) copper area for drain connection. PCB is vertical in still air.

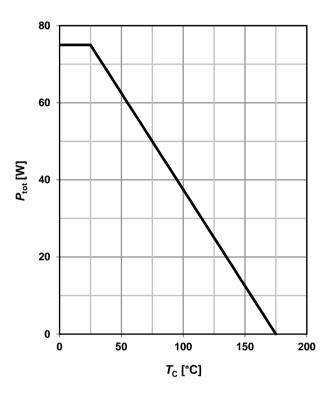


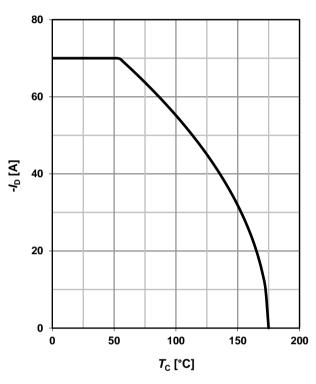
1 Power dissipation

$$P_{\text{tot}} = f(T_{\text{C}}); V_{\text{GS}} \le -6V$$

2 Drain current

$$I_{D} = f(T_{C}); V_{GS} = -10V$$





3 Safe operating area

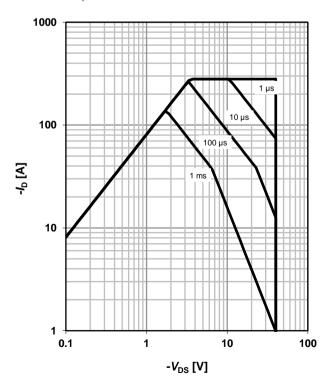
$$I_D = f(V_{DS}); T_C = 25 \text{ °C}; D = 0$$

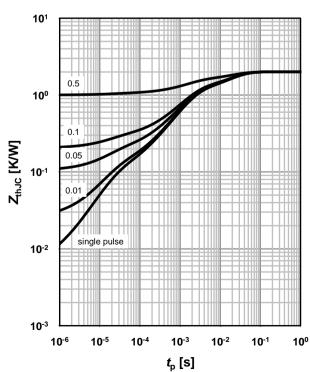
parameter: t_p

4 Max. transient thermal impedance

$$Z_{\text{thJC}} = f(t_{p})$$

parameter: $D=t_p/T$







5 Typ. output characteristics

 $I_{\rm D} = f(V_{\rm DS}); T_{\rm j} = 25 \,{}^{\circ}{\rm C}$

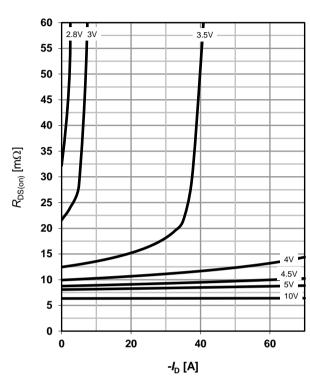
parameter: - V_{GS}

280 210 210 4.5V 70 0 0 2 4 6 -V_{DS} [V]

6 Typ. drain-source on-state resistance

 $R_{DS(on)} = (I_D); T_j = 25 \text{ °C}$

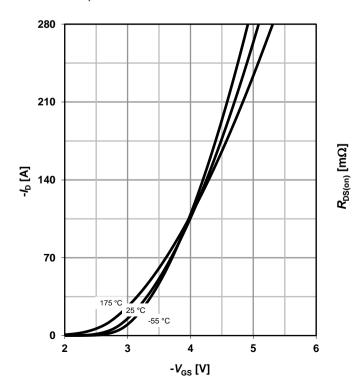
parameter: -V_{GS}



7 Typ. transfer characteristics

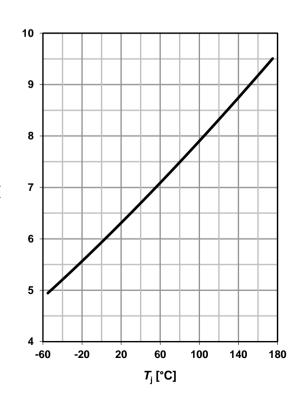
 $I_{D} = f(V_{GS}); V_{DS} = -6V$

parameter: $T_{\rm j}$



8 Typ. drain-source on-state resistance

$$R_{DS(on)} = f(T_j); I_D = -70 \text{ A}; V_{GS} = -10 \text{ V}$$





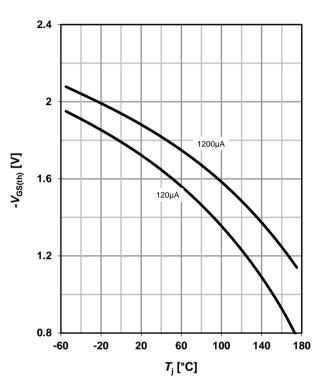
9 Typ. gate threshold voltage

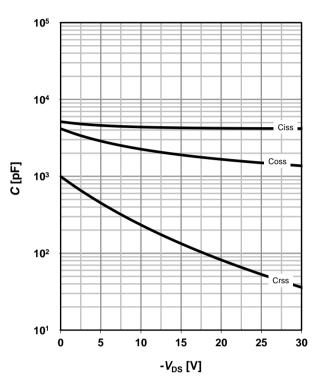
 $V_{GS(th)} = f(T_j); V_{GS} = V_{DS}$

parameter: -I_D

10 Typ. capacitances

 $C = f(V_{DS}); V_{GS} = 0 \text{ V}; f = 1 \text{ MHz}$





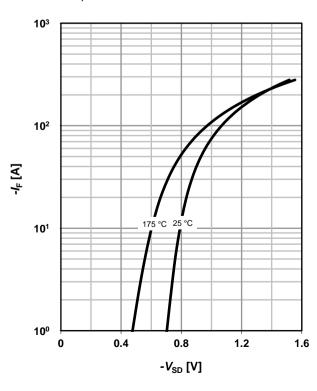
11 Typical forward diode characteristicis

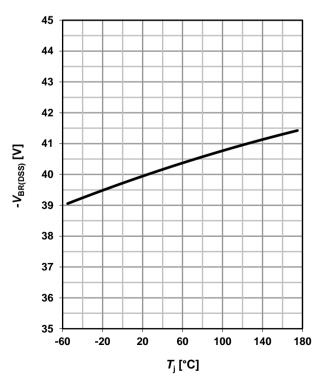
 $IF = f(V_{SD})$

parameter: $T_{\rm j}$

12 Drain-source breakdown voltage

$$V_{BR(DSS)} = f(T_j); I_D = -1 \text{ mA}$$





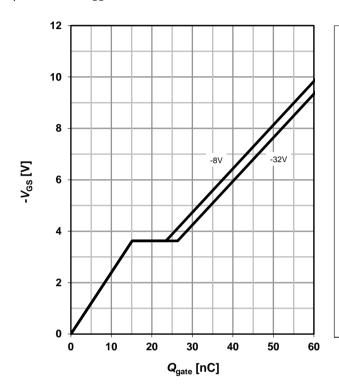


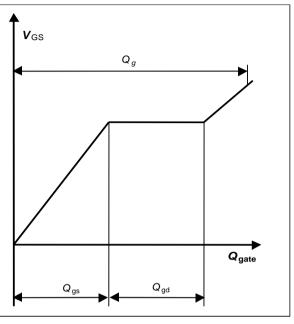
13 Typ. gate charge

14 Gate charge waveforms

 $V_{GS} = f(Q_{gate}); I_D = -70 A pulsed$

parameter: $V_{\rm DD}$







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Revision History

Version	Date	Changes
1.0	14.03.2011	Final Data Sheet
1.1	21.12.2012	Update of typical Rdson
1.2	04.07.2019	V _{GS} changed
1.21	19.08.2021	Editorial changes

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